Product Preview

Hybrid Power Module

Integrated Power Stage for 230 VAC Motor Drives

This module integrates a 3-phase inverter and 3-phase rectifier in a single convenient package. It is designed for 2.0 hp motor drive applications at frequencies up to 15 kHz. The inverter incorporates advanced EM-Series insulated gate bipolar transistors (IGBT) matched with ultrafast soft (UFS) free-wheeling diodes to give optimum performance. The input bridge uses rugged, efficient diodes with high surge capability. The top connector pins are designed for easy interfacing to the user's control board. It is pin-compatible with MHPM6B15E60D3 series modules for scalability.

- Short Circuit Rated 10 μs @ 125°C, 400 V
- Pin-to-Baseplate Isolation Exceeds 2500 Vac (rms)
- Compact Package Outline
- · Access to Positive and Negative DC Bus
- Gate-Emitter Clamp Diodes for ESD Protection
- UL Recognition Pending

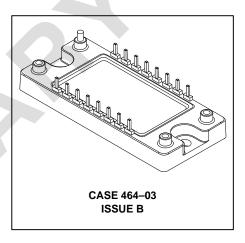
ORDERING INFORMATION

Device	Voltage	Current	Equivalent	
	Rating	Rating	Horsepower	
PHPM6B20E60D3	600	20	2.0	

MHPM6B20E60D3

Motorola Preferred Device

20 AMP, 600 VOLT HYBRID POWER MODULES



MAXIMUM DEVICE RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Repetitive Peak Input Rectifier Reverse Voltage (T _J = 25°C to 150°C)	VRRM	900	V
IGBT Reverse Voltage	VCES	600	V
Gate-Emitter Voltage	VGES	±20	V
Continuous IGBT Collector Current (T _C = 25°C)	I _{Cmax}	20	А
Continuous IGBT Collector Current (T _C = 80°C)	IC80	15	А
Repetitive Peak IGBT Collector Current (1)	IC(pk)	40	А
Continuous Free–Wheeling Diode Current (T _C = 25°C)	IFmax	20	А
Continuous Free–Wheeling Diode Current (T _C = 80°C)	I _{F80}	14	А
Repetitive Peak Free–Wheeling Diode Current (1)	IF(pk)	40	А
Average Converter Output Current (Peak–to–Average ratio of 10, T _C = 95°C)	I _{Omax}	20	А
Continuous Input Rectifier Current (T _C = 25°C)	IDC	20	А
Non–Repetitive Peak Input Rectifier Forward Surge Current (2) (T _J = 95°C prior to start of surge)	IFSM	475	А
IGBT Power Dissipation per die (T _C = 95°C)	PD	25	W
Free–Wheeling Diode Power Dissipation per die (T _C = 95°C)	PD	17	W
Input Rectifier Power Dissipation per die (T _C = 95°C)	PD	13	W

^{(1) 1.0} ms = 1.0% duty cycle

Preferred devices are Motorola recommended choices for future use and best overall value.

This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.



⁽²⁾ $1.0 \text{ ms} = 10\% \text{ pulse width } (t_w 10\%)$

MHPM6B20E60D3

MAXIMUM DEVICE RATINGS ($T_J = 25$ °C unless otherwise noted)

Rating	Symbol	Value	Unit
Junction Temperature Range	TJ	-40 to +150	°C
Short Circuit Duration (V _{CE} = 400 V, T _J = 125°C)	t _{SC}	10	μs
Isolation Voltage, pin to baseplate	Viso	2500	Vac
Operating Case Temperature Range	ТC	-40 to +95	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C
Mounting Torque — Heat Sink Mounting Holes	_	12	lb-in

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC AND SMALL SIGNAL CHARACTERISTICS	•		•		•
Input Rectifier Forward Voltage (I = 20 A) T _J = 125°C	VF	_	1.0 0.92	1.25 —	V
Maximum Instantaneous Reverse Current (V = 900 V) $T_J = 150$ °C	I _R	_	50 3000	_ _	μΑ
Gate–Emitter Leakage Current (V _{CE} = 0 V, V _{GE} = ±20 V)	l _{GES}	_	_	±50	μΑ
Collector–Emitter Leakage Current (V _{CE} = 600 V, V _{GE} = 0 V)	ICES	_	5.0	100	μΑ
Gate–Emitter Threshold Voltage (V _{CE} = V _{GE} , I _C = 1.0 mA)	VGE(th)	4.0	6.0	8.0	V
Collector–Emitter Breakdown Voltage (I _C = 10 mA, V _{GE} = 0 V)	V(BR)CES	600	_	_	V
Collector–Emitter Saturation Voltage ($I_C = I_{Cmax}$, $V_{GE} = 15 \text{ V}$) $T_J = 125$ °C	VCE(SAT)	_	2.2 2.5	2.6 —	V
Free–Wheeling Diode Forward Voltage (I _F = I _{Fmax} , V _{GE} = 0 V) T _J = 125°C	VF	_	2.0 1.8	2.3 —	V
Input Capacitance (V _{GE} = 0 V, V _{CE} = 10 V, f = 1.0 MHz)	C _{ies}	_	TBD	_	pF
THERMAL CHARACTERISTICS (EACH DIE)			•		•
Thermal Resistance — IGBT	$R_{ heta JC}$	_	1.8	2.2	°C/W
Thermal Resistance — Free–Wheeling Diode	$R_{ heta}$ JC	_	2.6	3.3	°C/W
Thermal Resistance — Input Rectifier	$R_{ heta JC}$	_	3.4	4.2	°C/W

2 Motorola IGBT Device Data

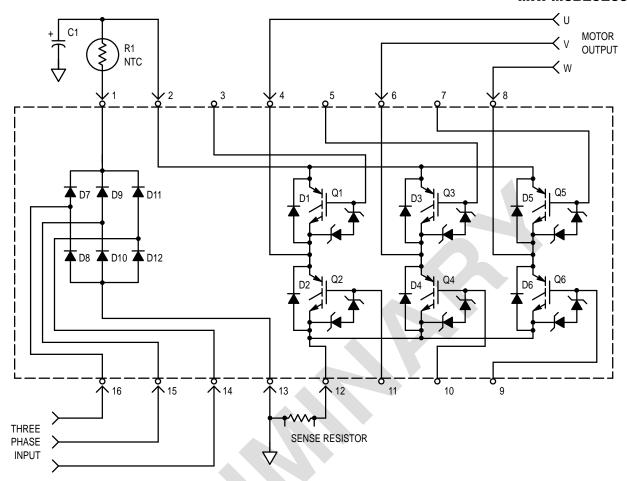


Figure 1. Schematic of Module, Showing Pin-Out and External Connections

Motorola IGBT Device Data 3

VIEW OF BOARD FROM HEAT SINK (All Dimensions Typical) KEEP-OUT ZONES (x4) NON-PLATED THRU-HOLE \emptyset 0.270 \emptyset 0.140 0.175 0.265 0.250 0.625 \emptyset 0.270 PIN 1 PLATED THRU-HOLES (x16) \emptyset 0.065 3.500 0.250 PACKAGE "SHADOW"

RECOMMENDED PCB LAYOUT

Figure 2. Package Footprint

1.350

1.530

 \emptyset 0.450

OPTIONAL NON-PLATED

SCREWS (x2)

THRU-HOLES FOR ACCESS TO HEAT SINK MOUNTING

0.175

NOTE:

1. Package is symmetrical, except for a polarizing plastic post near pin 1, indicated by a non-plated thru-hole in the footprint.

0.175

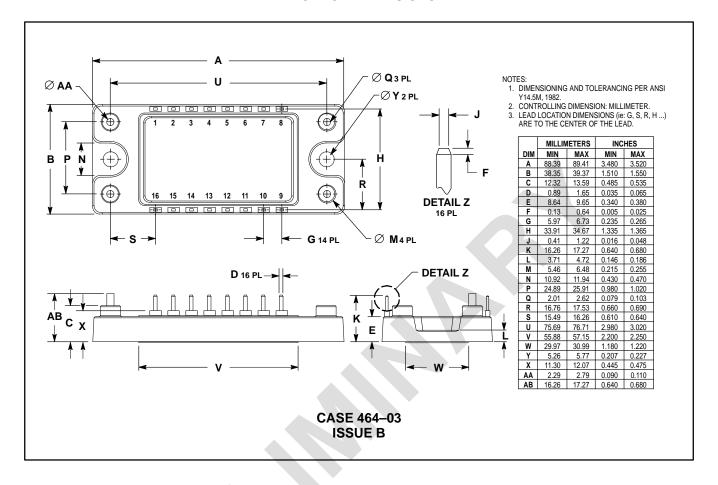
2. Dimension of plated thru-holes indicates net size after plating.

0.625

3. Access holes for mounting screws may or may not be necessary depending on assembly plan for finished product.

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PACKAGE DIMENSIONS



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